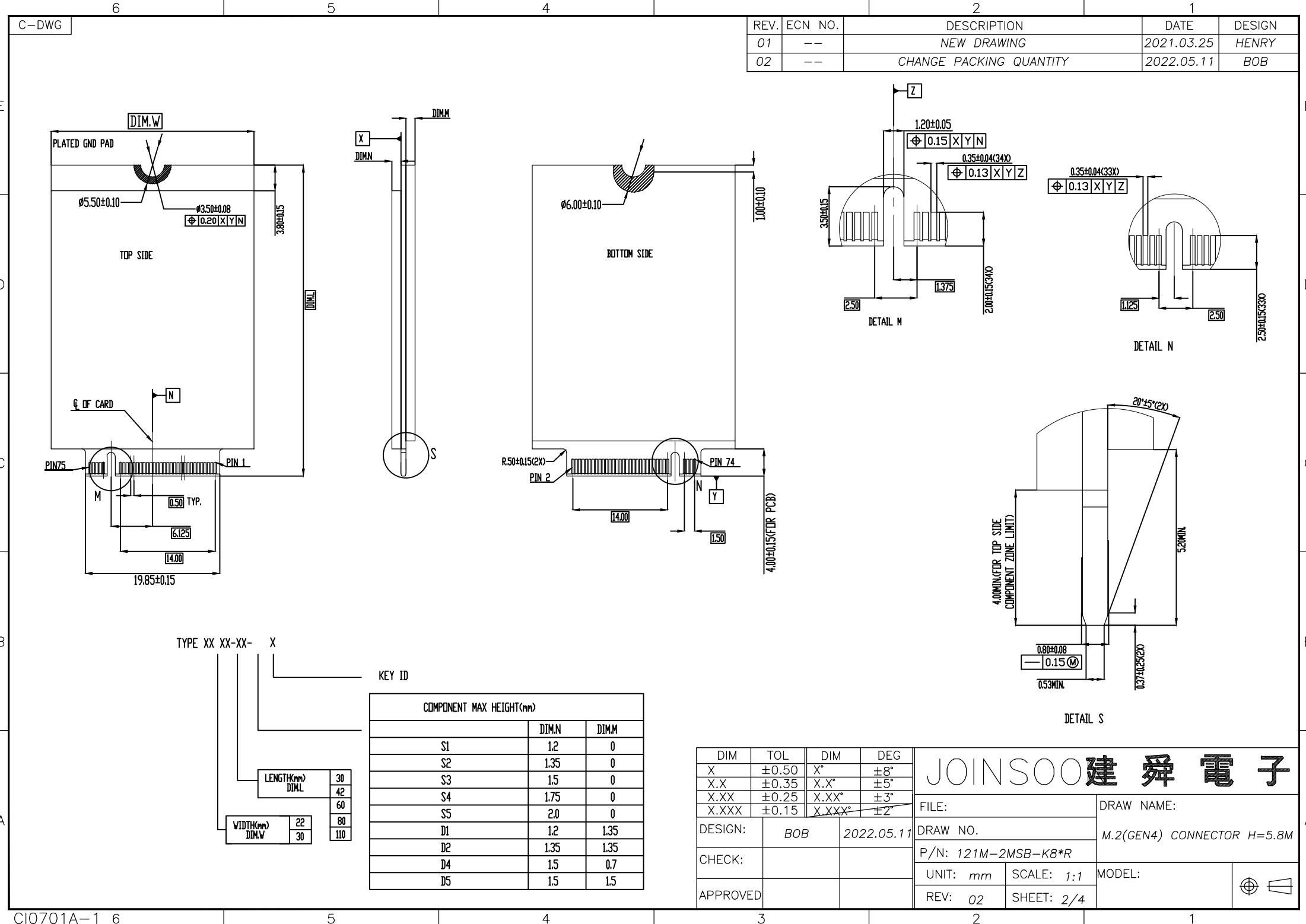
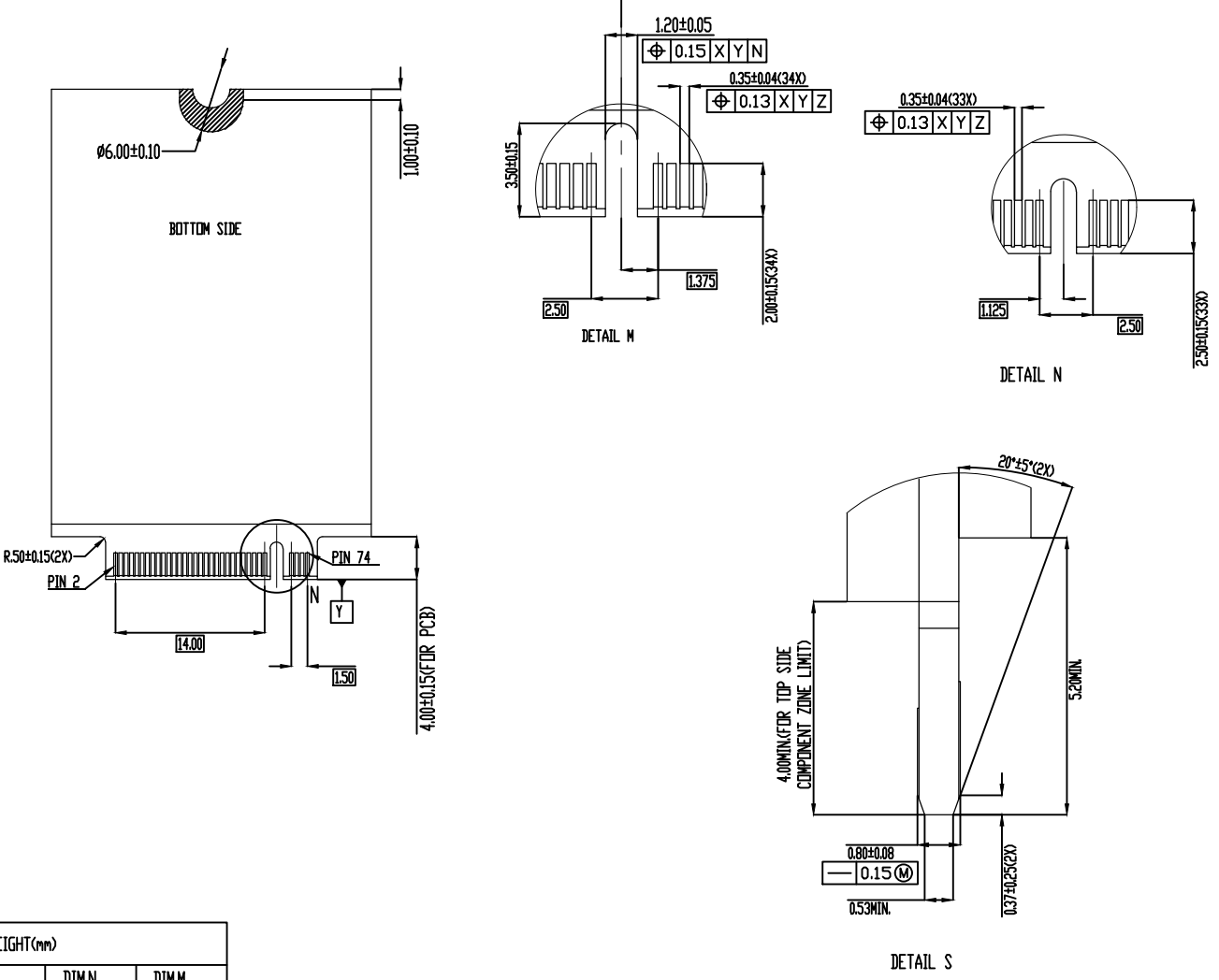




REV.	ECN NO.	DESCRIPTION	DATE	DESIGN
01	--	NEW DRAWING	2021.03.25	HENRY
02	--	CHANGE PACKING QUANTITY	2022.05.11	BOB



TYPE XX XX-XX- X	KEY ID
LENGTH(mm)	30
DIML	42
	60
	80
WIDTH(mm)	22
DIM.W	30
	110

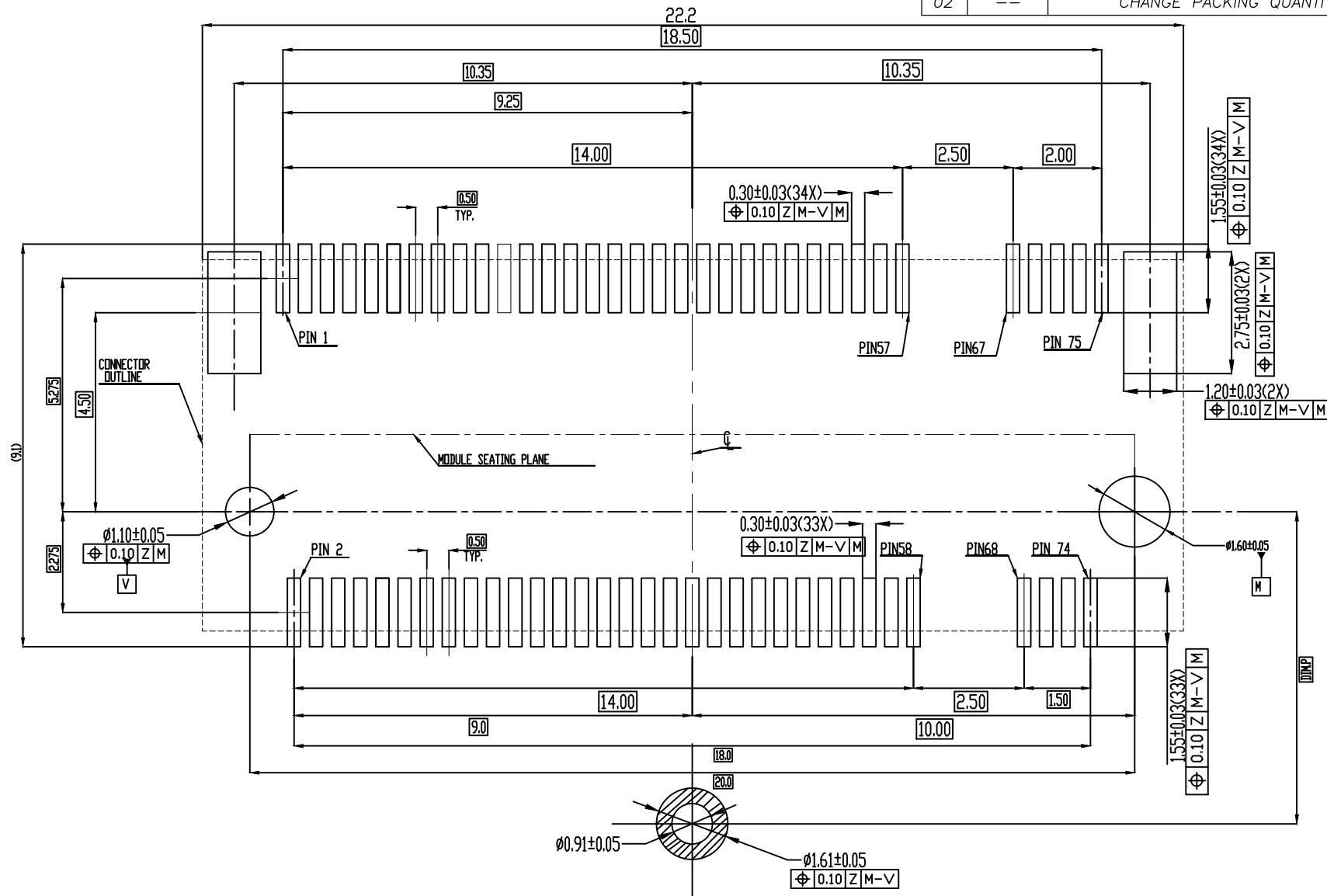
COMPONENT MAX HEIGHT(mm)		
	DIM.N	DIM.M
S1	1.2	0
S2	1.35	0
S3	1.5	0
S4	1.75	0
S5	2.0	0
D1	1.2	1.35
D2	1.35	1.35
D4	1.5	0.7
D5	1.5	1.5

DIM	TOL	DIM	DEG
X	±0.50	X°	±8°
X.X	±0.35	X.X°	±5°
X.XX	±0.25	X.XX°	±3°
X.XXX	±0.15	X.XXX°	±2°

DESIGN:	BOB	2022.05.11
CHECK:		
APPROVED		

JOINSOO建舜電子

FILE:	DRAW NAME:	
P/N: 121M-2MSB-K8*R	M.2(GEN4) CONNECTOR H=5.8MM	
UNIT: mm	SCALE: 1:1	MODEL:
REV: 02	SHEET: 2/4	



DATUM Z IS THE PCB SOLDER SURFACE
STENCIL RECOMMENDED THICKNESS=0.13 MM

DIM	TOL	DIM	DEG
X	±0.50	X°	±8°
X.X	±0.35	X.X°	±5°
X.XX	±0.25	X.XX°	±3°
X.XXX	±0.15	X.XXX°	±2°
DESIGN:	BOB	2022.05.1	
CHECK:			
APPROVED			

JOINSOO建舜電子

FILE:	DRAW NAME: <i>M.2(GEN4) CONNECTOR H=5.8M</i>
DRAW NO.	

P/N: 121M-2MSB-K8*R			
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UNIT: <i>mm</i>	SCALE: <i>1:1</i>	MODEL:	
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REV: 02	SHEET: 3/4		
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